

DS2016 2k x 8 3V/5V Operation Static RAM

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FEATURES

- Low-power CMOS design
- Standby current
 - 50nA max at $t_A = +25$ °C $V_{CC} = 3.0$ V
 - 100nA max at $t_A = +25$ °C $V_{CC} = 5.5$ V
 - $-1 \mu A \text{ max at } t_A = +60 ^{\circ} \text{C V}_{CC} = 5.5 \text{V}$
- Full operation for $V_{CC} = 5.5 \text{V}$ to 2.7V
- Data retention voltage = 5.5V to 2.0V
- Fast 5V access time
 - DS2016-100 100ns
- Reduced-speed 3V access time
 - DS2016-100 250ns
- Operating temperature range of -40°C to +85°C
- Full static operation
- TTL compatible inputs and outputs over voltage range of 5.5V to 2.7V
- Available in 24-pin DIP and 24-pin SO packages
- Suitable for both battery operated and battery backup applications

PIN ASSIGNMENT

A3	A1
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DS2016 24-Pin DIP (600mil) DS2016R 24-Pin SO (300mil)

PIN DESCRIPTION

A0 to A10 - Address Inputs
DQ0 to DQ7 - Data Input/Output
CE - Chip Enable Input
WE - Write Enable Input
OE - Output Enable Input

V_{CC} - Power Supply Input 2.7V - 5.5V

GND - Ground

DESCRIPTION

The DS2016 2k x 8 3V/5V Operation Static RAM is a 16,384-bit, low-power, fully static random access memory organized as 2048 words by 8 bits using CMOS technology. The device operates from a single power supply with a voltage input between 2.7V and 5.5V. The chip enable input ($\overline{\text{CE}}$) is used for device selection and can be used in order to achieve the minimum standby current mode, which facilitates both battery operated and battery backup applications. The device provides access times as fast as 100ns when operated from a 5V power supply input and also provides relatively good performance of 250ns access while operating from a 3V input. The device maintains TTL-level inputs and outputs over the input voltage range of 2.7V to 5.5V. The DS2016 is most suitable for low-power applications where battery operation or battery backup for nonvolatility is required. The DS2016 is a JEDEC-standard 2k x 8 SRAM and is pin-compatible with ROM and EPROM of similar density.

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OPERATION MODE

MODE	CE	OE	WE	A0-A10	DQ-DQ7	POWER
READ	L	L	Н	STABLE	DATA OUT	I_{CCO}
WRITE	L	X	L	STABLE	DATA IN	I_{CCO}
DESELECT	L	Н	Н	X	HIGH-Z	I_{CCO}
STANDBY	Н	X	X	X	HIGH-Z	I_{CCS}

ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	RATING
V_{CC}	Power Supply Voltage	-0.3V to +7.0V
$V_{\rm IN}$, $V_{\rm I/O}$	Input, Input/Output Voltage	-0.3 to V _{CC} +0.3V
T_{STG}	Storage Temperature	-55°C to +125°C
T_{OPR}	Operating Temperature	-40°C to +85°C
T _{SOLDER}	Soldering Temperature/Time	IPC/JEDEC J-STD-020

CAPACITANCE (T_A=

+25°C)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Input Capacitance	C_{IN}		5	10	pF	
Input/Output Capacitance	$C_{I/O}$		5	12	pF	

+5-VOLT OPERATION

RECOMMENDED DC OPERATING CONDITIONS

 $(T_A = -40^{\circ}C \text{ to } +85^{\circ}C)$

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Power Supply Voltage	V_{CC}	4.5	5.0	5.5	V	
Input High Voltage	$ m V_{IH}$	2.0		$V_{CC} + 0.3$	V	
Input Low Voltage	$V_{ m IL}$	-0.3		0.8	V	
Data Retention Voltage	V_{DR}	2.0		5.5	V	

DC CHARACTERISTICS

 $(T_A = -40^{\circ}C \text{ to } +85^{\circ}C; V_{CC} = 5V \pm 10\%)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Leakage Current	I_{IL}	$0V \leq V_{IN} \leq V_{CC}$			± 0.1	μΑ
I/O Leakage Current	I_{LO}	$\overline{\text{CE}} = V_{\text{IH}}, 0V \le V_{\text{IO}} \le V_{\text{CC}}$			± 0.5	μA
Output High Current	I_{OH}	$V_{OH} = 2.4V$	-1.0			mA
Output Low Current	I_{OL}	$V_{\rm OL} = 0.4 V$	4.0			mA
Standby Current	I _{CCS1}	$\overline{\mathrm{CE}} = 2.0\mathrm{V}$			0.3	mA
Standby Current	I _{CCS2}	$\overline{CE} \ge V_{CC} - 0.5V, t_A =$			1	μΑ
		+60°C				
Standby Current	I_{CCS2}	$\overline{\text{CE}} \ge V_{\text{CC}} - 0.5 \text{V}, t_{\text{A}} =$			100	nA
		+25°C				
Operating Current	I_{CCO}	$\overline{\text{CE}} = 0.8 \text{V}, 200 \text{ns cycle}$			55	mA

AC CHARACTERISTICS READ CYCLE $(T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}; V_{CC} = 5\text{V} \pm 10\%)$

PARAMETER	SYMBOL	DS2016-100					UNITS	NOTES
PARAMETER	SYMBOL	MIN	TYP	MAX			UNITS	NOTES
Read Cycle Time	t_{RC}	100					ns	
Access Time	t_{ACC}			100			ns	
OE to Output Valid	t_{OE}			50			ns	
CE to Output Valid	t_{CO}			100			ns	
CE or OE to Output Active	$t_{\rm COE}$	5					ns	
Output High-Z from Deselection	t _{OD}	5		35			ns	
Output Hold from Address Change	t _{OH}	5					ns	

AC CHARACTERISTICS WRITE CYCLE $(T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}; V_{CC} = 5\text{V } \pm 10\%)$

PARAMETER	SYMBOL	DS2016-100			UNITS	NOTES	
IANAMETER	SYMBOL	MIN	TYP	MAX		UNIIS	NOIES
Write Cycle Time	t_{WC}	100				ns	
Write Pulse Width	t_{WP}	75				ns	
Address Setup Time	t_{AW}	0				ns	
Write Recovery Time	t_{WR}	10				ns	
Output High-Z from $\overline{\text{WE}}$	t_{ODW}			35		ns	
Output Active from $\overline{\text{WE}}$	$t_{ m OEW}$	5				ns	
Data Setup Time	$t_{ m DS}$	40				ns	
Data Hold Time	t _{DH}	0				ns	

DATA RETENTION CHARACTERISTICS $(T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C})$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Data Retention Supply Voltage	V_{DR}	$\overline{\text{CE}} \ge V_{\text{CC}} - 0.5V$	2.0		5.5	V
Data Retention Current at 5.5V	I _{CCR1}	$\overline{\text{CE}} \ge V_{\text{CC}} - 0.5V$		0.1*	1	μΑ
Data Retention Current at 2.0V	I _{CCR2}	$\overline{\text{CE}} \ge V_{\text{CC}} - 0.5 \text{V}$		50*	750	nA
Chip Deselect to Data Retention	t_{CDR}		0			μs
Recovery Time	t_R		2			ms

^{*} Typical values are at +25°C

+3-VOLT OPERATION

RECOMMENDED DC OPERATING CONDITIONS

 $(T_A = -40^{\circ}C \text{ to } +85^{\circ}C)$

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Power Supply Voltage	V_{CC}	2.7	3.0	3.5	V	
Input High Voltage	$ m V_{IH}$	2.0		$V_{CC} + 0.3$	V	
Input Low Voltage	$V_{ m IL}$	-0.3		0.6	V	
Data Retention Voltage	V_{DR}	2.0		3.5	V	

DC CHARACTERISTICS

 $(T_A = -40^{\circ}C \text{ to } +85^{\circ}C; V_{CC} = 2.7V \text{ to } 3.5V)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Leakage Current	I_{IL}	$0V \leq V_{IN} \leq V_{CC}$			±0.1	μΑ
I/O Leakage Current	I_{LO}	$\overline{\text{CE}} = V_{\text{IH}}, 0V \le V_{\text{IO}} \le V_{\text{CC}}$			±0.5	μΑ
Output High Current	I_{OH}	$V_{OH} = 2.2V$	-0.5			mA
Output Low Current	I_{OL}	$V_{\rm OL} = 0.4 V$	4.0			mA
Standby Current	I _{CCS1}	$\overline{\mathrm{CE}} = 2.0\mathrm{V}$			0.1	mA
Standby Current	I _{CCS2}	$\overline{\text{CE}} \ge \text{V}_{\text{CC}} - 0.3 \text{V}, \text{T}_{\text{A}} = +60^{\circ} \text{C}$			500	nA
Standby Current	I _{CCS2}	$\overline{\text{CE}} \ge \text{V}_{\text{CC}} - 0.3 \text{V}, \text{T}_{\text{A}} = +25^{\circ}\text{C}$			50	nA
Operating Current	I_{CCO}	$\overline{\text{CE}} = 0.6\text{V} \text{ min cycle}$			25	mA

AC CHARACTERISTICS READ CYCLE

 $(T_A = -40^{\circ}C \text{ to } +85^{\circ}C; V_{CC} = 2.7V \text{ to } 3.5V)$

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Read Cycle Time	t_{RC}	250			ns	
Access Time	t_{ACC}			250	ns	
OE to Output Valid	t_{OE}			120	ns	
CE to Output Valid	t_{CO}			250	ns	
$\overline{\text{CE}}$ or $\overline{\text{OE}}$ to Output Active	$t_{\rm COE}$	15			ns	
Output High-Z from Deselection	t _{OD}	5		100	ns	
Output Hold from Address Change	t _{OH}	15			ns	

AC CHARACTERISTICS WRITE CYCLE

 $(T_A = -40^{\circ}C \text{ to } +85^{\circ}C; V_{CC} = 2.7V \text{ to } 3.5V)$

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Write Cycle Time	$t_{ m WC}$	250			ns	
Write Pulse Width	t_{WP}	190			ns	
Address Setup Time	$t_{ m AW}$	0			ns	
Write Recovery Time	$t_{ m WR}$	25			ns	
Output High-Z from WE	$t_{ m ODW}$			90	ns	
Output Active from WE	$t_{ m OEW}$	5			ns	
Data Setup Time	$t_{ m DS}$	100			ns	
Data Hold Time	$t_{ m DH}$	0			ns	

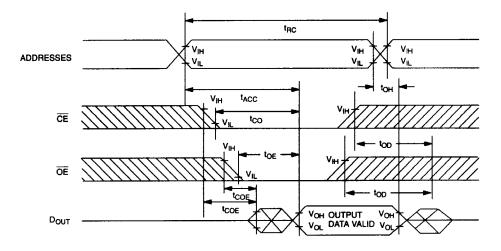
DATA RETENTION CHARACTERISTICS

 $(T_A = -40^{\circ}C \text{ to } +85^{\circ}C)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Data Retention	$V_{ m DR}$	$\overline{\text{CE}} \ge \text{V}_{\text{CC}} - 0.3\text{V}$	2.0		3.5	V
Supply Voltage	V DR	CE ≥ V _{CC} = 0.3 V	2.0		J.J	V
Data Retention	I _{CCR1}	$\overline{\text{CE}} \ge \text{V}_{\text{CC}} - 0.3\text{V}$		50*	1000	nA
Current at 3.5V				30	1000	ПA
Data Retention	I _{CCR2}	$\overline{\text{CE}} \ge \text{V}_{\text{CC}} - 0.3\text{V}$		50*	750	nA
Current at 2.0V				30.	730	IIA
Chip Deselect to	t_{CDR}		0			μs
Data Retention						
Recovery Time	t_R		2			ms

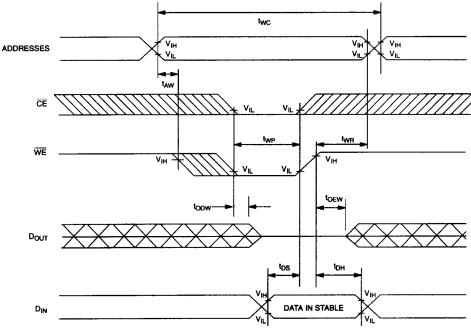
^{*} Typical values are at +25°C

TIMING DIAGRAM: READ CYCLE



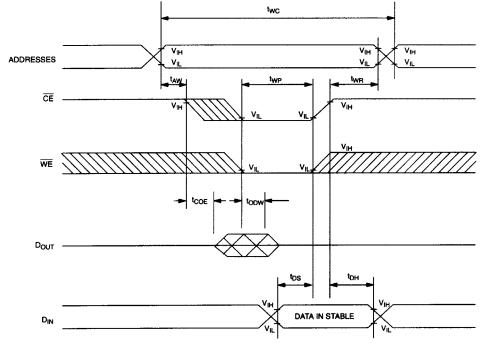
SEE NOTE 1

TIMING DIAGRAM: WRITE CYCLE 1



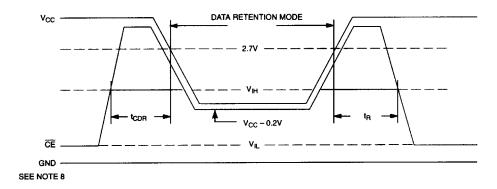
SEE NOTES 2, 3, 4, 5, 6, AND 7

TIMING DIAGRAM: WRITE CYCLE 2



SEE NOTES 2, 3, 4, 5, 6, AND 7

TIMING DIAGRAM: DATA RETENTION - POWER-UP, POWER-DOWN Figure 1



SEE NOTE 8

NOTES:

- 1) $\overline{\text{WE}}$ is high for read cycles.
- 2) $\overline{OE} = V_{IH}$ or V_{IL} . If $\overline{OE} = V_{IH}$ during write cycle, the output buffers remain in a high impedance state.
- 3) t_{WP} is specified as the logical AND of \overline{CE} and \overline{WE} . t_{WP} is measured from the latter of \overline{CE} or \overline{WE} going low to the earlier of \overline{CE} or \overline{WE} going high.
- 4) t_{DH} and t_{DS} are measured from the earlier of \overline{CE} or \overline{WE} going high.
- 5) If the $\overline{\text{CE}}$ low transition occurs simultaneously with or later than the $\overline{\text{WE}}$ low transition, the output buffers remain in a high impedance state.
- 6) If the $\overline{\text{CE}}$ high transition occurs prior to or simultaneously with the $\overline{\text{WE}}$ high transition, the output buffers remain in a high impedance state.
- 7) If $\overline{\text{WE}}$ is low or the $\overline{\text{WE}}$ low transition occurs prior to or simultaneously with the $\overline{\text{CE}}$ low transition, the output buffers remain in a high impedance state.
- 8) If the V_{IH} level of CE is 2.0V during the period that V_{CC} voltage is going down from 4.5V to 2.7V, I_{CCS1} current flows.
- 9) The DS2016 maintains full operation from 5.5V to 2.7V. The electrical characteristics tables show two tested and guaranteed points of operation. For operation between 4.5V and 3.5V, use the composite worst case characteristics from both 5V and 3V operation for design purposes.

DC TEST CONDITIONS

Outputs Open

All voltages are referenced to ground.

AC TEST CONDITIONS

Output Load: 100pF + 1TTL Gate Input Pulse Levels: 0V - 3.0V

Timing Measurement Reference Levels

Input: 1.5V Output: 1.5V

Input Pulse Rise and Fall Times: 5ns

PACKAGE INFORMATION

For the latest package outline information, go to www.maxim-ic.com/DallasPackInfo.